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Renesas Electronics website: http://www.renesas.com

April 1st, 2010 Renesas Electronics Corporation

Issued by: Renesas Electronics Corporation (http://www.renesas.com)

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RENESAS HD74HC393 Dual 4-bit Binary Counters

REJ03D0625-0200 (Previous ADE-205-504) Rev.2.00 Mar 30, 2006

Description

The HD74HC393 contain two 4-bit ripple carry binary counters, which can be cascaded to create a single divide-by-256 counter.

The HD74HC393 is incremented on the high to low transition (negative edge) of the clock input, and each has an independent clear input. When clear is set high all four bits of each counter are set to a low level. This enables count truncation and allows the implementation of divide-by-N counter configurations.

Features

- High Speed Operation: t_{pd} (A to Q_A) = 16 ns typ (C_L = 50 pF)
- High Output Current: Fanout of 10 LSTTL Loads
- Wide Operating Voltage: $V_{CC} = 2 \text{ to } 6 \text{ V}$
- Low Input Current: 1 µA max
- Low Quiescent Supply Current: I_{CC} (static) = 4 μ A max (Ta = 25°C)
- Ordering Information

Part Name	Package Type	Package Code (Previous Code)	Package Abbreviation	Taping Abbreviation (Quantity)
HD74HC393P	DILP-14 pin	PRDP0014AB-B (DP-14AV)	Ρ	—
HD74HC393FPEL	SOP-14 pin (JEITA)	PRSP0014DF-B (FP-14DAV)	FP	EL (2,000 pcs/reel)

Note: Please consult the sales office for the above package availability.

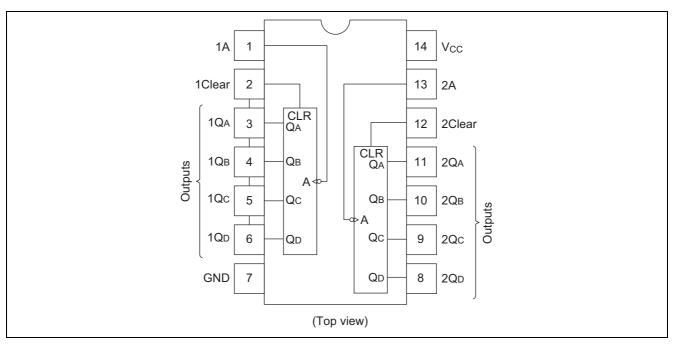
Function Table

Clock	Clear	Outputs
X	Н	L
Н	L	No change
L	L	No change
	L	No change
	L	Advance to next state

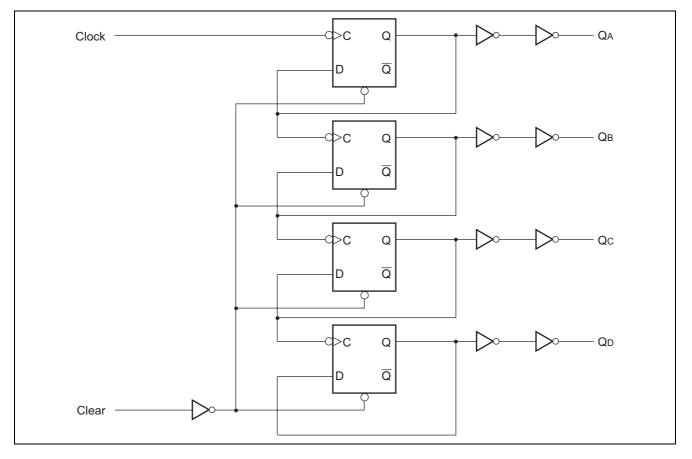
Note: 1. H; High level, L; Low level, X; Irrelevant



Pin Arrangement



Logic Diagram





Absolute Maximum Ratings

Item	Symbol	Ratings	Unit	
Supply voltage range	V _{CC}	-0.5 to 7.0	V	
Input / Output voltage	V _{IN} , V _{OUT}	–0.5 to V _{CC} +0.5	V	
Input / Output diode current	I _{IK} , I _{OK}	±20	mA	
Output current	I _{OUT}	±25	mA	
V _{CC} , GND current	I _{CC} or I _{GND}	±50	mA	
Power dissipation	P _T	500	mW	
Storage temperature	Tstg	-65 to +150	°C	

Note: The absolute maximum ratings are values, which must not individually be exceeded, and furthermore, no two of which may be realized at the same time.

Recommended Operating Conditions

ltem	Symbol	Ratings	Unit	Conditions
Supply voltage	V _{CC}	2 to 6	V	
Input / Output voltage	$V_{\text{IN}}, V_{\text{OUT}}$	0 to V _{CC}	V	
Operating temperature	Та	-40 to 85	°C	
		0 to 1000		V _{CC} = 2.0 V
Input rise / fall time ^{*1}	t _r , t _f	0 to 500	ns	$V_{CC} = 4.5 V$
		0 to 400		$V_{CC} = 6.0 V$

Note: 1. This item guarantees maximum limit when one input switches. Waveform: Refer to test circuit of switching characteristics.

Electrical Characteristics

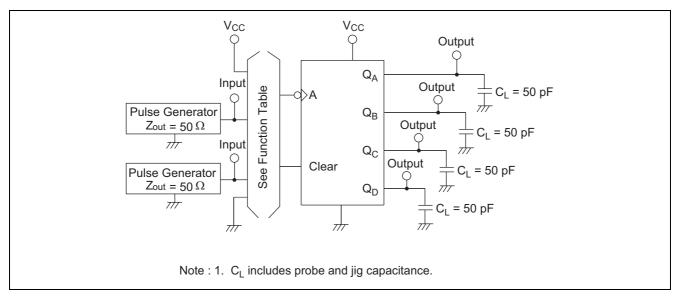
			Т	a = 25°	С	Ta = -40 to+85°C				
Item	Symbol	V _{cc} (V)	Min	Тур	Max	Min	Max	Unit	Test Con	ditions
Input voltage	VIH	2.0	1.5	_	—	1.5	_	V		
		4.5	3.15		—	3.15				
		6.0	4.2		—	4.2				
	VIL	2.0			0.5		0.5	V		
		4.5			1.35		1.35			
		6.0			1.8		1.8			
Output voltage	V _{OH}	2.0	1.9	2.0	_	1.9		V	$Vin = V_{IH} \text{ or } V_{IL}$	I _{OH} = -20 μA
		4.5	4.4	4.5	_	4.4				
		6.0	5.9	6.0	_	5.9				
		4.5	4.18		_	4.13				$I_{OH} = -4 \text{ mA}$
		6.0	5.68		_	5.63				$I_{OH} = -5.2 \text{ mA}$
	V _{OL}	2.0		0.0	0.1		0.1	V	$Vin = V_{IH} \text{ or } V_{IL}$	$I_{OL} = 20 \ \mu A$
		4.5		0.0	0.1		0.1			
		6.0	_	0.0	0.1	—	0.1			
		4.5	_	_	0.26	—	0.33			I _{ОН} = 4 mA
		6.0	_	_	0.26	—	0.33			I _{OH} = 5.2 mA
Input current	lin	6.0			±0.1	_	±1.0	μΑ	Vin = V _{CC} or GND	
Quiescent supply current	I _{CC}	6.0		_	4.0		40	μA	$Vin = V_{CC} \text{ or } GN$	D, Iout = 0 μ A



			Ta = 25°C		Ta = -40 to +85°C				
Item	Symbol	V _{cc} (V)	Min	Тур	Max	Min	Max	Unit	Test Conditions
Maximum clock	f _{max}	2.0	_	_	5	_	4	MHz	
frequency		4.5		_	25	_	20		
		6.0		_	29		24		
Propagation delay	t _{PLH}	2.0		_	120	—	150	ns	Clock to Q _A
time	t _{PHL}	4.5		16	24	—	30		
		6.0		_	20		26		
	t _{PLH}	2.0		_	185	_	230	ns	Clock to Q _B
	t _{PHL}	4.5		20	37	_	46		
		6.0		_	31	_	39		
	t _{PLH}	2.0	_	_	220	_	275	ns	Clock to Q _C
	t _{PHL}	4.5		24	44	_	55		
		6.0		_	37	_	47		
	t _{PLH}	2.0		_	260	_	325	ns	Clock to Q _D
	t _{PHL}	4.5		28	52	_	65		
		6.0		_	44		55		
	t _{PHL}	2.0		_	150	_	190	ns	Clear to Q _A , Q _B , Q _C , Q _D
		4.5		21	30	—	38		
		6.0		_	28	_	33		
Pulse width	t _w	2.0	80	_	_	100		ns	Clock, clear
		4.5	16	_	_	20			
		6.0	14	_	_	17			
Removal time	t _h	2.0	50	_	_	65		ns	Clear to clock
		4.5	10	_	_	13			
		6.0	9	—	—	11			
Output rise/fall	t _{TLH}	2.0		—	75	—	95	ns	
time	t _{THL}	4.5		5	15		19		
		6.0		—	13	—	16		
Input capacitance	Cin	_	_	5	10	_	10	pF	

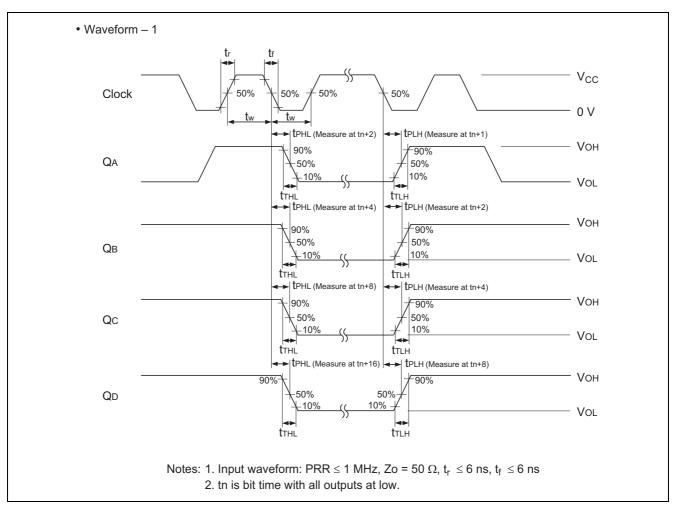
Switching Characteristics ($C_L = 50 \text{ pF}$, Input $t_r = t_f = 6 \text{ ns}$)

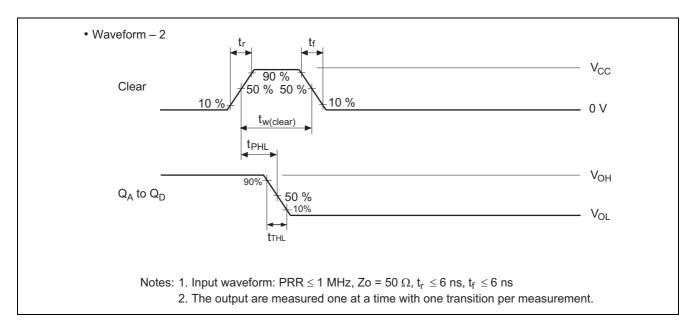
Test Circuit





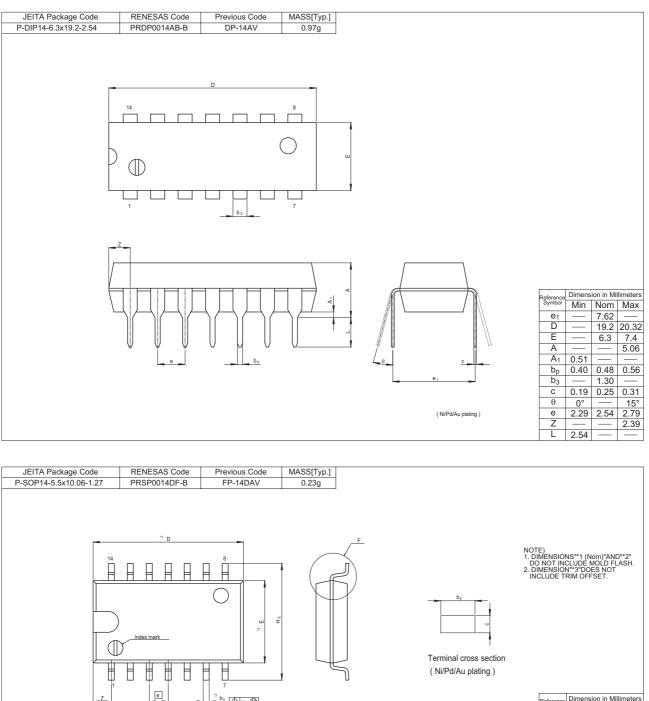
Waveforms

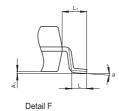






Package Dimensions





Reference	Dimension in Millimeters						
Symbol	Min	Nom	Max				
D		10.06	10.5				
Е		5.50	—				
A ₂	—						
A ₁	0.00	0.10	0.20				
Α			2.20				
bp	0.34	0.40	0.46				
b1			—				
С	0.15	0.20	0.25				
C1							
θ	0°		8°				
HE	7.50	7.80	8.00				
е		1.27	—				
х			0.12				
У			0.15				
Z			1.42				
L	0.50	0.70	0.90				
L ₁		1.15					



⁻³ b_p ⊕ × ₪

□у

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